

| Title of Change: | Qualification of Amkor Technology Malaysia (ATM) for the Assembly and Test of Trench MOSFET products packaged in SO8FL and Trench 6 Technology Capacity Expansion by Qualification ON Semiconductor Aizu, Japan. | | | |
|--|--|--|--|--|
| Proposed first ship date: | 1 May 2019 or earlier after customer approval. | | | |
| Contact information: | Contact your local ON Semiconductor Sales Office < <u>GuoKun.Yeng@onsemi.com></u> | | | |
| Samples: | Contact your local ON Semiconductor Sales Office or < <u>PCN.samples@onsemi.com</u> > Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change. | | | |
| Additional Reliability Data: | Contact your local ON Semiconductor Sales Office or < <u>MohdAzizi.Azman@onsemi.com>.</u> < <u>Don.Knudsen@onsemi.com></u> | | | |
| Type of notification: | This is a Final Product/Process Change Notification (FPCN) sentto customers. FPCNs are issued 90 days prior to implementation of the change. ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact < <u>PCN.Support@onsemi.com></u> | | | |
| Change Part Identification: | Product from Amkor Technology Malaysia will be marked with site code YE prior to date code. | | | |
| Change Category: | ✓ Wafer Fab Change ✓ Assembly Change ✓ Test Change Other | | | |
| Change Sub-Category(s): ✓ Manufacturing Site Addition ✓ Manufacturing Site Transfer ✓ Manufacturing Site Transfer ✓ Manufacturing Process Change | | Datasheet/Product Doc change Shipping/Packaging/Marking Other: | | |
| Sites Affected: | ON Semiconductor Sites: ON Semiconductor Aizu | External Foundry/Subcon Sites: Amkor Malaysia | | |
| Description and Purpose: | | • | | |
| This Product Change Notice is to announce that ON Semiconductor is: | | | | |
| a) Expandingassembly and test operations of SO8FL discrete packaged products, currently built at ON Semiconductor Seremban, Mala ysia facility to Amkor Technology Malaysia (ATM). | | | | |
| b) Qualification of additional wafer fabrication capacity of 30V Trench (T6) MOSFET technology in ON Semiconductor Aizu, located in Japan. | | | | |
| There are no product material changes and no product marking change as a result of this change. | | | | |
| Upon the expiration of this FPCN or earlier after customer approval, Trench Mosfet devices maybe processed at either location. These products have been qualified to commodity/commercial requirements. These products will continue being Pb -free, Halide free and RoHS compliant. | | | | |
| Device quality and reliability will continue to meet ON Semiconductors high standards. | | | | |



Reliability Data Summary:

Qual Vehicle: NTMFS4C302NT1G (Amkor qualification)

| Test | Specification | Condition | Interval | Results |
|-------|------------------------------------|--|-----------|---------|
| HTRB | JESD22-A108 | Ta=150°C, 80% max rated V | 1008 hrs | 0/252 |
| HTGB | JESD22-A108 | Ta=150°C, 100% max rated Vgss | 1008 hrs | 0/252 |
| HTSL | JESD22-A103 | Ta= 150°C | 1008 hrs | 0/252 |
| IOL | MIL-STD-750 (M1037) AEC-Q101 | Ta=+25°C, delta Tj=100°C On/off = 2 min | 15000 cyc | 0/252 |
| TC | JESD22-A104 | Ta= -55°C to +150°C | 1000 сус | 0/252 |
| HAST | JESD22-A110 | 130°C, 85% RH, 18.8psig, bias | 96 hrs | 0/252 |
| uHAST | JESD22-A118 | 130°C, 85% RH, 18.8psig, unbiased | 96 hrs | 0/252 |
| PC | J-STD-020 JESD-A113 | MSL 1 @ 260 °C | | 0/1008 |
| RSH | JESD22- B106 | Ta = 265°C, 10 sec | | 0/90 |
| SD | JSTD002 | Ta = 245°C, 10 sec | | 0/45 |

Qual Vehicle: NVMFS4C01NT1G (Aizu qualification)

| Test | Specification | Condition | Interval | Results |
|-------|------------------------------------|--|----------|---------|
| HTRB | JESD22-A108 | Ta=175°C, 100% max rated V | 1008 hrs | 0/240 |
| HTGB | JESD22-A108 | Ta=175°C, 100% max rated Vgss | 1008 hrs | 0/240 |
| HTSL | JESD22-A103 | Ta= 175 | 1008 hrs | 0/240 |
| IOL | MIL-STD-750 (M1037) AEC-Q101 | Ta=+25°C, delta Tj=100°C On/off = 2 min | 15К сус | 0/240 |
| TC | JESD22-A104 | Ta= -55°C to +150°C | 1000 сус | 0/240 |
| HAST | JESD22-A110 | 130°C, 85% RH, 18.8psig, bias | 96 hrs | 0/240 |
| uHAST | JESD22-A118 | 130°C, 85% RH, 18.8psig, unbiased | 96 hrs | 0/240 |
| PC | J-STD-020 JESD-A113 | MSL 1 @ 260 °C | | |
| RSH | JESD22- B106 | Ta = 265C, 10 sec | | 0/90 |

Electrical Characteristic Summary:

Electrical characteristics are not impacted.

List of Affected Parts:

Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the <u>PCN Customized Portal</u>.

| Part Number | Qualification Vehicle | |
|---------------|-----------------------|--|
| NTMFS4C50NT1G | NTMFS4C302NT1G | |
| NTMFS4C59NT1G | NVMFS4C01NT1G | |